

Sensor Die Attach to FR4 Ceramic or PCB

Sensor Die Attach Materials							
Paste		Fil	lm				
LOCTITE ABLESTIK 2025J	LOCTITE ABLESTIK 2035SC	LOCTITE ABLI	ESTIK ATB 125				

Properties		Units	LOCTITE ABLESTIK 2025J	LOCTITE ABLESTIK 2035SC	LOCTITE ABLESTIK ATB 125
Туре			Paste	Paste	Film
Viscosity (Brookfield CP51 / 5 rpm)		mPa.s	12,900	11,000	-
Thickness		μm	-	-	25
Glass Transition Temperature (Tg)		°C	22	120	215
Modulus @	25°C	N / mm²	320	2,500	5,256
СТЕ	below	ppm / °C	45	54	37
	above		135	128	83
Recommended Cure			30 min. ramp to 175°C + 15 min. @ 175°C	90 sec. @ 110°C	30 min. ramp + 1 hr. @ 130°C
Alternative Cure			-	30 min. @ 80°C	-

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